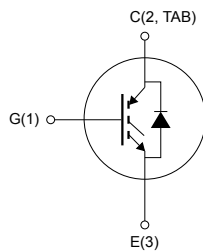


Trench gate field-stop, 1200 V, 25 A, low-loss, M series IGBT in a TO-247 long leads package



TO-247 long leads



NG1E3C2T

Features

- Maximum junction temperature: $T_J = 175\text{ °C}$
- 10 μs of short-circuit withstand time
- Low $V_{CE(sat)} = 1.85\text{ V (typ.) @ } I_C = 25\text{ A}$
- Tight parameter distribution
- Positive $V_{CE(sat)}$ temperature coefficient
- Low thermal resistance
- Soft- and fast-recovery antiparallel diode

Applications

- Industrial drives
- UPS
- Solar
- Welding

Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where the low-loss and the short-circuit functionality is essential. Furthermore, the positive $V_{CE(sat)}$ temperature coefficient and the tight parameter distribution result in safer paralleling operation.

Product status link

[STGWA25M120DF3](#)

Product summary

Order code	STGWA25M120DF3
Marking	G25M120DF3
Package	TO-247 long leads
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$ V)	1200	V
I_C	Continuous collector current at $T_C = 25$ °C	50	A
	Continuous collector current at $T_C = 100$ °C	25	A
$I_{CP}^{(1)}$	Pulsed collector current	100	A
V_{GE}	Gate-emitter voltage	±20	V
	Transient gate-emitter voltage	±30	V
I_F	Continuous forward current at $T_C = 25$ °C	50	A
	Continuous forward current at $T_C = 100$ °C	25	A
$I_{FP}^{(1)}$	Pulsed forward current	100	A
P_{TOT}	Total dissipation at $T_C = 25$ °C	375	W
T_{STG}	Storage temperature range	-55 to 150	°C
T_J	Operating junction temperature range	-55 to 175	°C

1. Pulse width is limited by maximum junction temperature.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case IGBT	0.4	°C/W
	Thermal resistance junction-case diode	0.96	°C/W
R_{thJA}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

$T_J = 25\text{ °C}$ unless otherwise specified

Table 3. Static characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE} = 0\text{ V}, I_C = 2\text{ mA}$	1200			V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE} = 15\text{ V}, I_C = 25\text{ A}$		1.85	2.3	V
		$V_{GE} = 15\text{ V}, I_C = 25\text{ A}, T_J = 125\text{ °C}$		2.1		
		$V_{GE} = 15\text{ V}, I_C = 25\text{ A}, T_J = 175\text{ °C}$		2.2		
V_F	Forward on-voltage	$I_F = 25\text{ A}$		2.95	4.1	V
		$I_F = 25\text{ A}, T_J = 125\text{ °C}$		2.95		
		$I_F = 25\text{ A}, T_J = 175\text{ °C}$		1.9		
$V_{GE(th)}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1\text{ mA}$	5	6	7	V
I_{CES}	Collector cut-off current	$V_{GE} = 0\text{ V}, V_{CE} = 1200\text{ V}$			25	μA
I_{GES}	Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = \pm 20\text{ V}$			± 250	nA

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies}	Input capacitance	$V_{CE} = 25\text{ V}, f = 1\text{ MHz}, V_{GE} = 0\text{ V}$	-	1550	-	pF
C_{oes}	Output capacitance		-	180	-	
C_{res}	Reverse transfer capacitance		-	65	-	
Q_g	Total gate charge	$V_{CC} = 960\text{ V}, I_C = 25\text{ A}, V_{GE} = 0\text{ to }15\text{ V}$ (see Figure 29. Gate charge test circuit)	-	85	-	nC
Q_{ge}	Gate-emitter charge		-	11.5	-	
Q_{gc}	Gate-collector charge		-	45.5	-	

Table 5. IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$t_{d(on)}$	Turn-on delay time	$V_{CE} = 600\text{ V}$, $I_C = 25\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 15\ \Omega$ (see Figure 28. Test circuit for inductive load switching)		28	-	ns	
t_r	Current rise time			15	-	ns	
$(di/dt)_{on}$	Turn-on current slope			1370	-	A/ μ s	
$t_{d(off)}$	Turn-off delay time			150	-	ns	
t_f	Current fall time			155	-	ns	
$E_{on}^{(1)}$	Turn-on switching energy			0.85	-	mJ	
$E_{off}^{(2)}$	Turn-off switching energy			1.3	-	mJ	
E_{ts}	Total switching energy			2.15	-	mJ	
$t_{d(on)}$	Turn-on delay time		$V_{CE} = 600\text{ V}$, $I_C = 25\text{ A}$, $V_{GE} = 15\text{ V}$, $R_G = 15\ \Omega$, $T_J = 175\text{ }^\circ\text{C}$ (see Figure 28. Test circuit for inductive load switching)		28	-	ns
t_r	Current rise time				17	-	ns
$(di/dt)_{on}$	Turn-on current slope			1270	-	A/ μ s	
$t_{d(off)}$	Turn-off delay time			155	-	ns	
t_f	Current fall time			240	-	ns	
$E_{on}^{(1)}$	Turn-on switching energy			1.6	-	mJ	
$E_{off}^{(2)}$	Turn-off switching energy			1.9	-	mJ	
E_{ts}	Total switching energy			3.5	-	mJ	
t_{sc}	Short-circuit withstand time	$V_{CC} \leq 600\text{ V}$, $V_{GE} = 15\text{ V}$, $T_{Jstart} \leq 150\text{ }^\circ\text{C}$	10		-	μ s	

1. Including the reverse recovery of the diode
2. Including the tail of the collector current

Table 6. Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
t_{rr}	Reverse recovery time	$I_F = 25\text{ A}$, $V_R = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $di/dt = 1000\text{ A}/\mu\text{s}$ (see Figure 28. Test circuit for inductive load switching)	-	265	-	ns	
Q_{rr}	Reverse recovery charge			-	1.2	-	μ C
I_{rrm}	Reverse recovery current			-	19	-	A
dl_{rr}/dt	Peak rate of fall of reverse recovery current during t_b			-	1090	-	A/ μ s
E_{rr}	Reverse recovery energy			-	0.22	-	μ J
t_{rr}	Reverse recovery time		$I_F = 25\text{ A}$, $V_R = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$, $di/dt = 1000\text{ A}/\mu\text{s}$ (see Figure 28. Test circuit for inductive load switching)	-	585	-	ns
Q_{rr}	Reverse recovery charge			-	5	-	μ C
I_{rrm}	Reverse recovery current			-	30	-	A
dl_{rr}/dt	Peak rate of fall of reverse recovery current during t_b			-	270	-	A/ μ s
E_{rr}	Reverse recovery energy			-	0.75	-	μ J

2.1 Electrical characteristics (curves)

Figure 1. Power dissipation vs case temperature

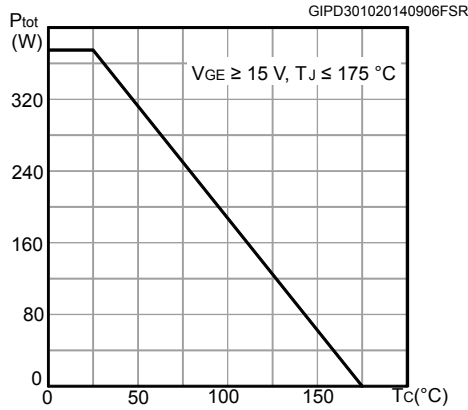


Figure 2. Collector current vs case temperature

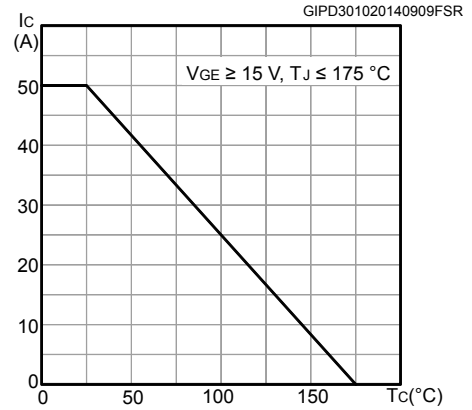


Figure 3. Output characteristics ($T_J = 25^\circ C$)

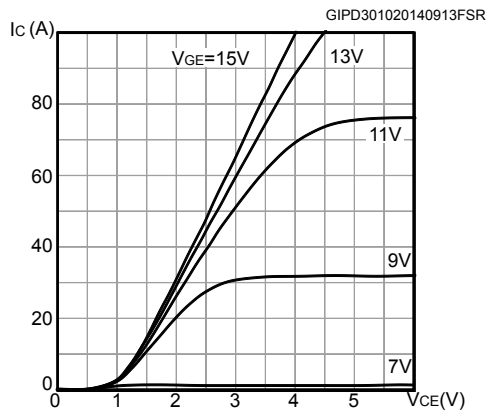


Figure 4. Output characteristics ($T_J = 175^\circ C$)

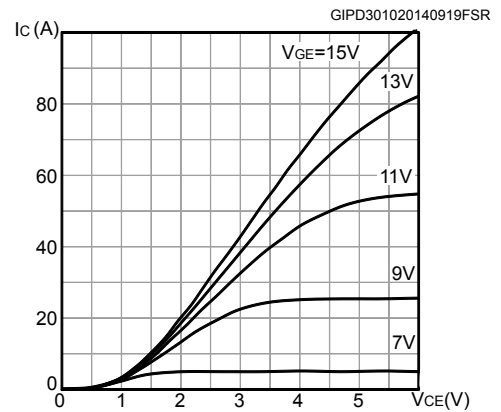


Figure 5. $V_{CE(sat)}$ vs junction temperature

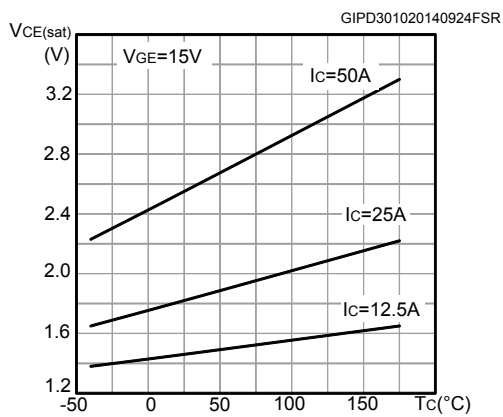


Figure 6. $V_{CE(sat)}$ vs collector current

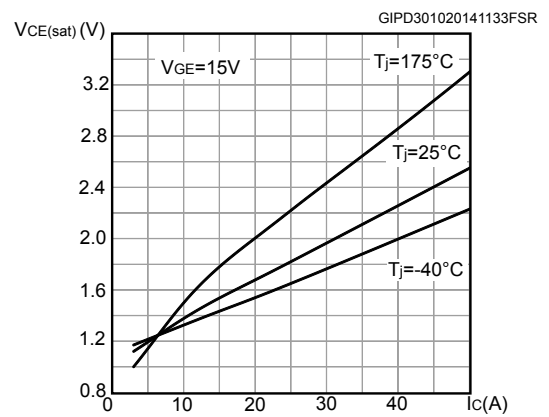


Figure 7. Collector current vs switching frequency

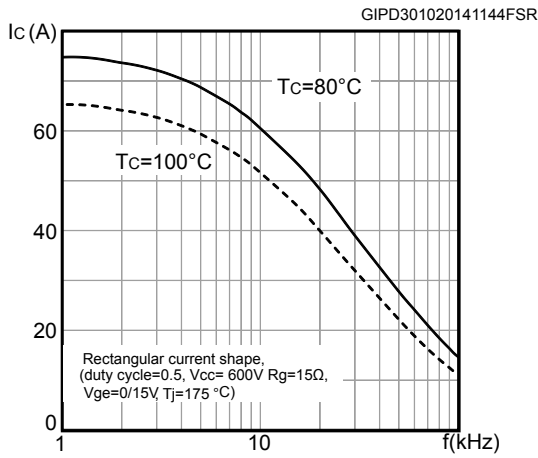


Figure 8. Safe operating area

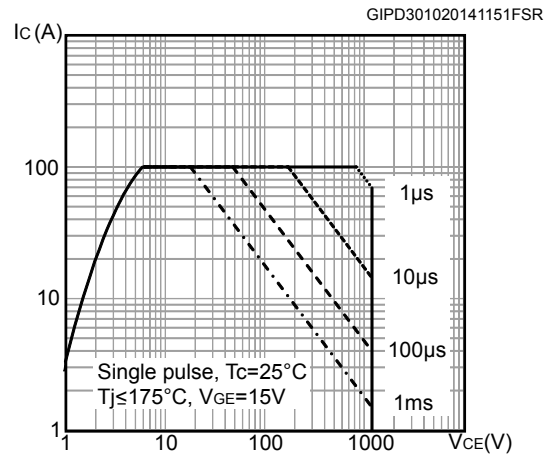


Figure 9. Transfer characteristics

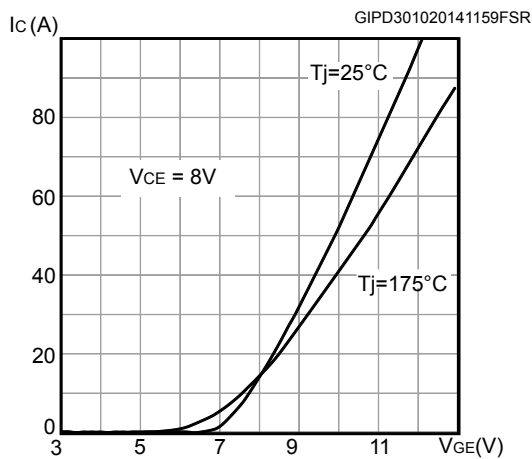


Figure 10. Diode Vf vs forward current

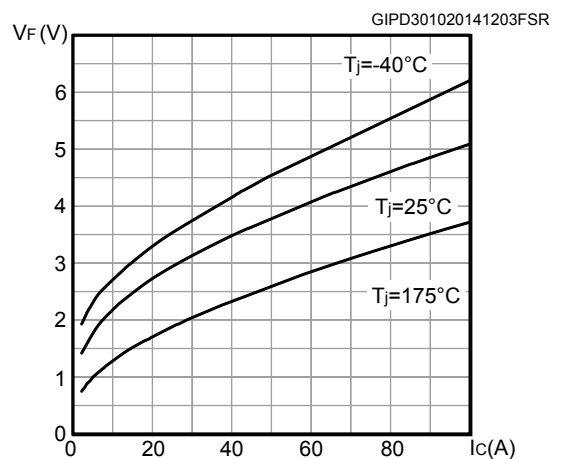


Figure 11. Normalized $V_{GE(th)}$ vs junction temperature

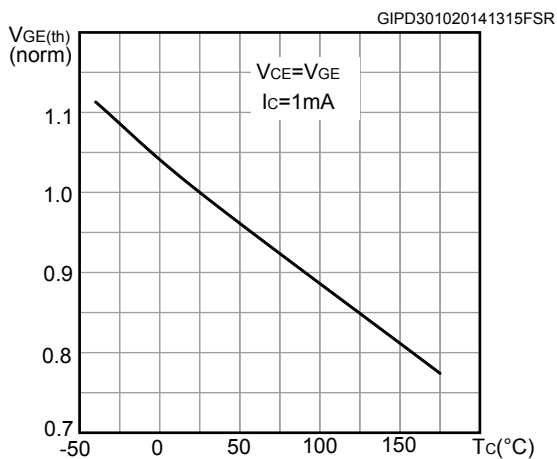


Figure 12. Normalized $V_{(BR)CES}$ vs junction temperature

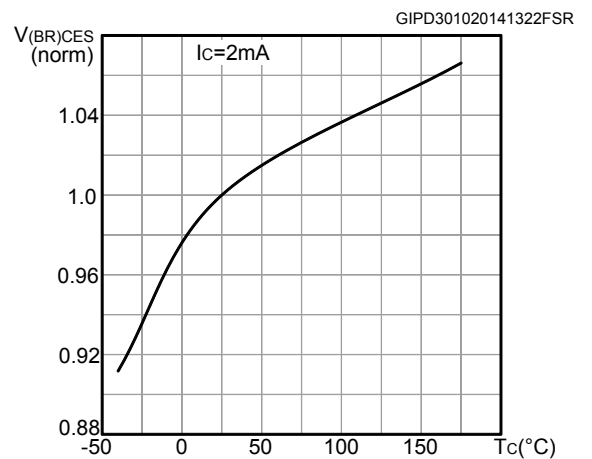


Figure 13. Capacitance variations

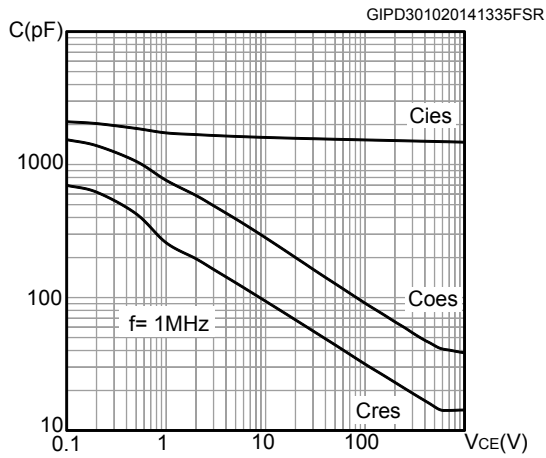


Figure 14. Gate charge vs gate-emitter voltage

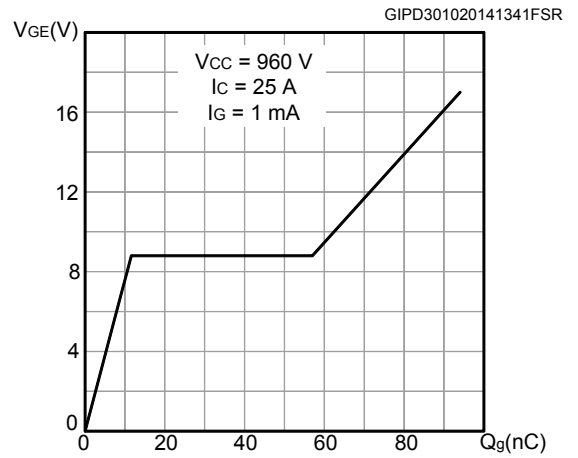


Figure 15. Switching energy vs collector current

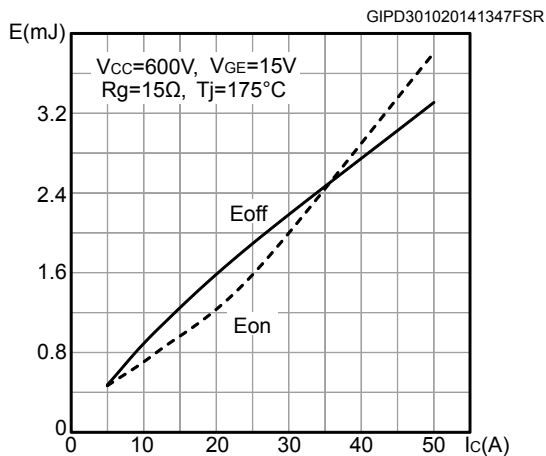


Figure 16. Switching energy vs gate resistance

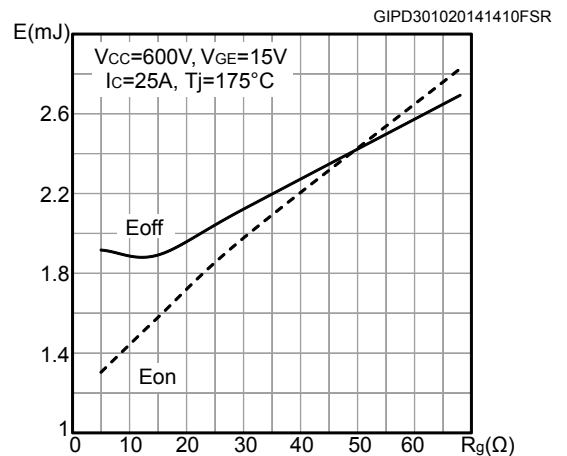


Figure 17. Switching energy vs junction temperature

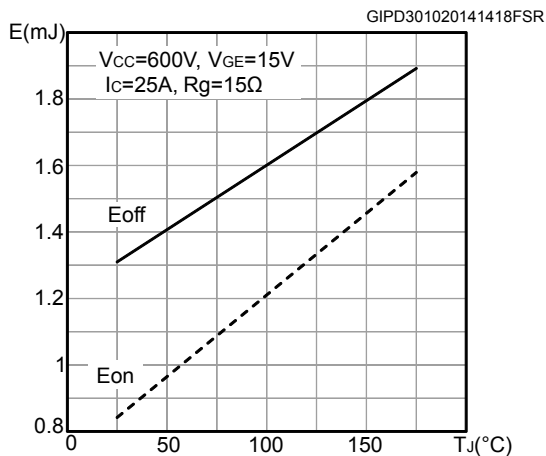


Figure 18. Switching energy vs collector emitter voltage

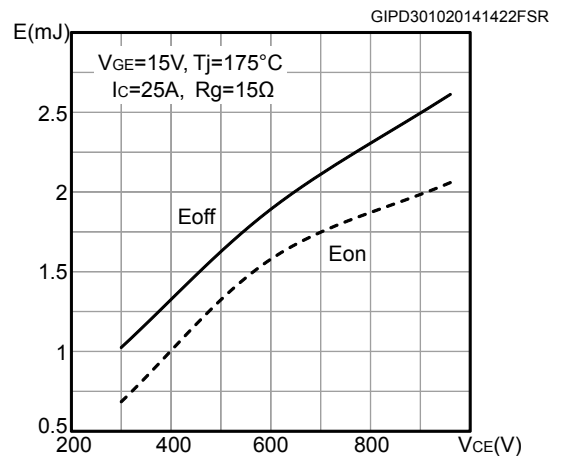


Figure 19. Short-circuit time and current vs V_{GE}

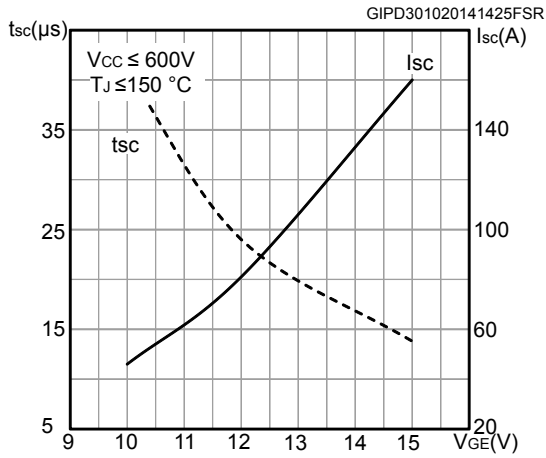


Figure 20. Switching times vs collector current

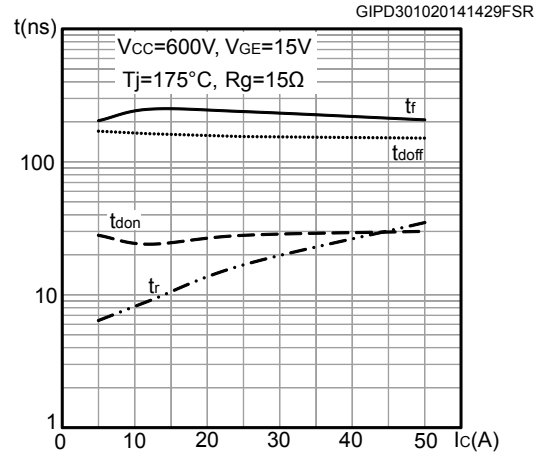


Figure 21. Switching times vs gate resistance

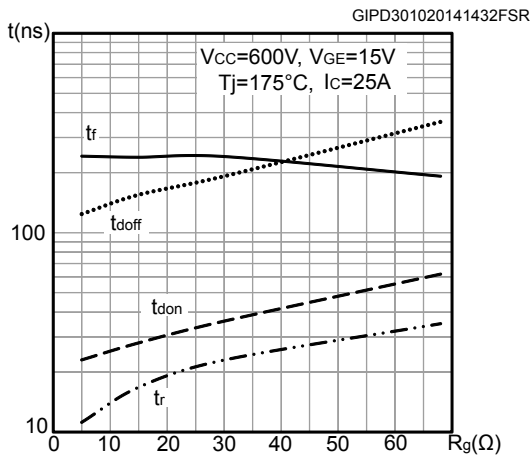


Figure 22. Reverse recovery current vs diode current slope

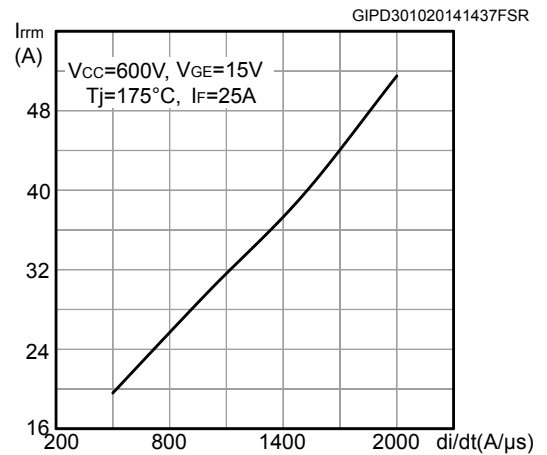


Figure 23. Reverse recovery time vs diode current slope

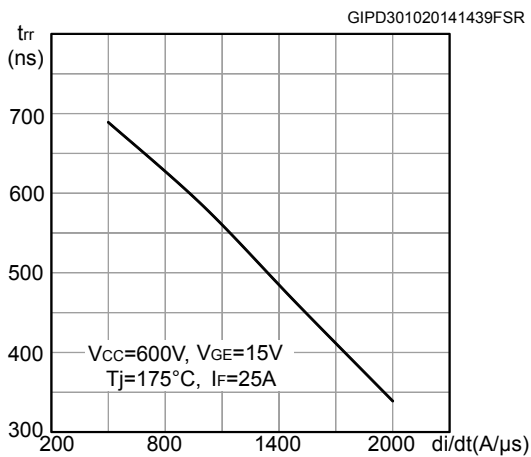


Figure 24. Reverse recovery charge vs diode current slope

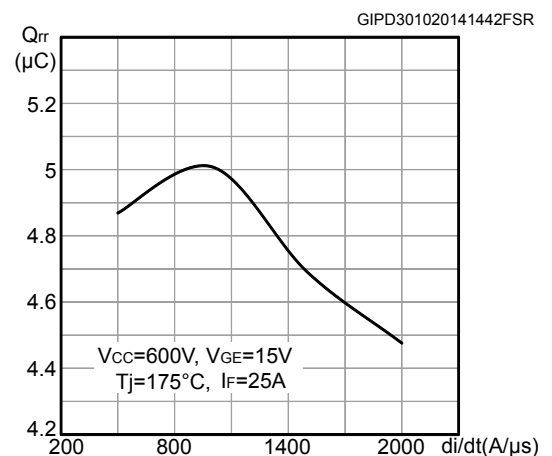


Figure 25. Reverse recovery energy vs diode current slope

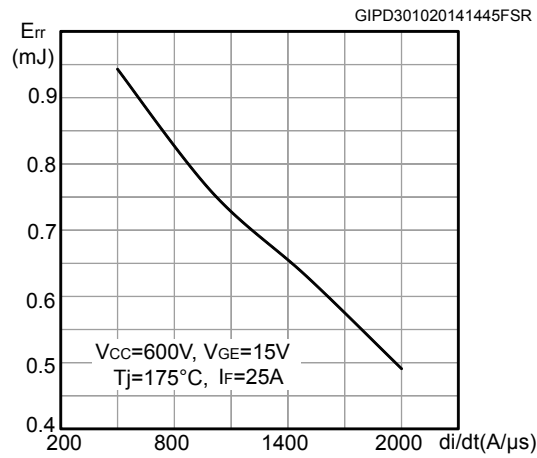


Figure 26. Thermal impedance for IGBT

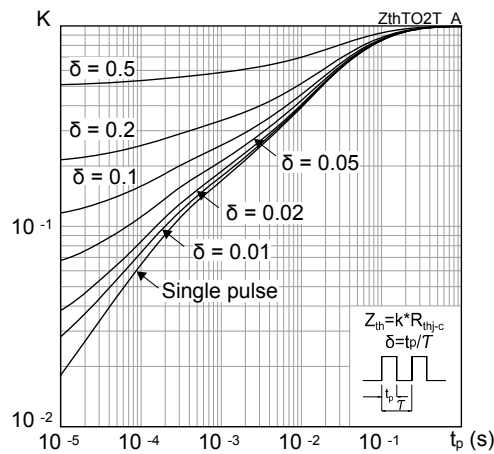
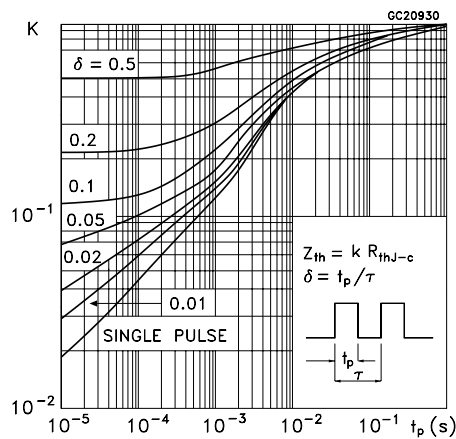
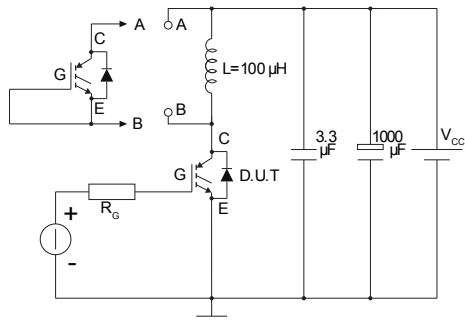


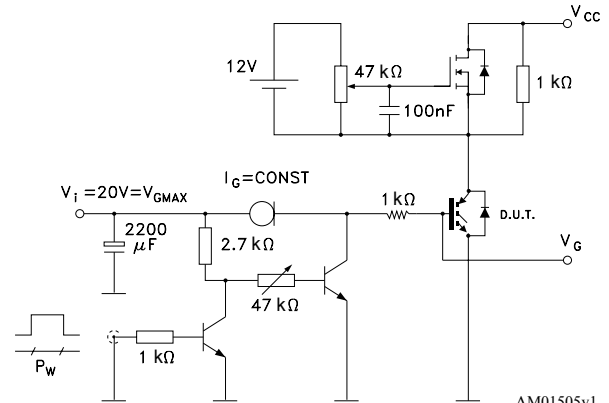
Figure 27. Thermal impedance for diode



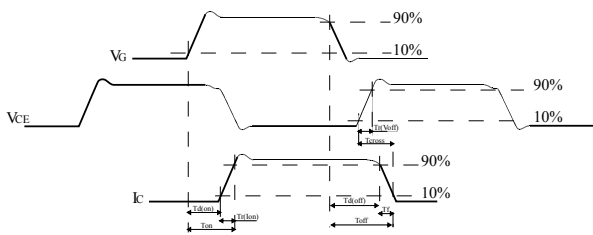
3 Test circuits

Figure 28. Test circuit for inductive load switching


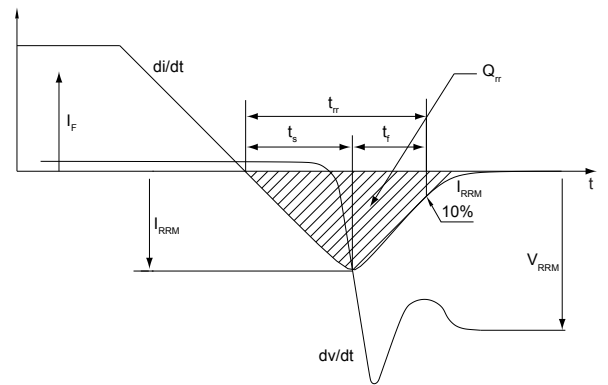
AM01504v1

Figure 29. Gate charge test circuit


AM01505v1

Figure 30. Switching waveform


AM01506v1

Figure 31. Diode reverse recovery waveform


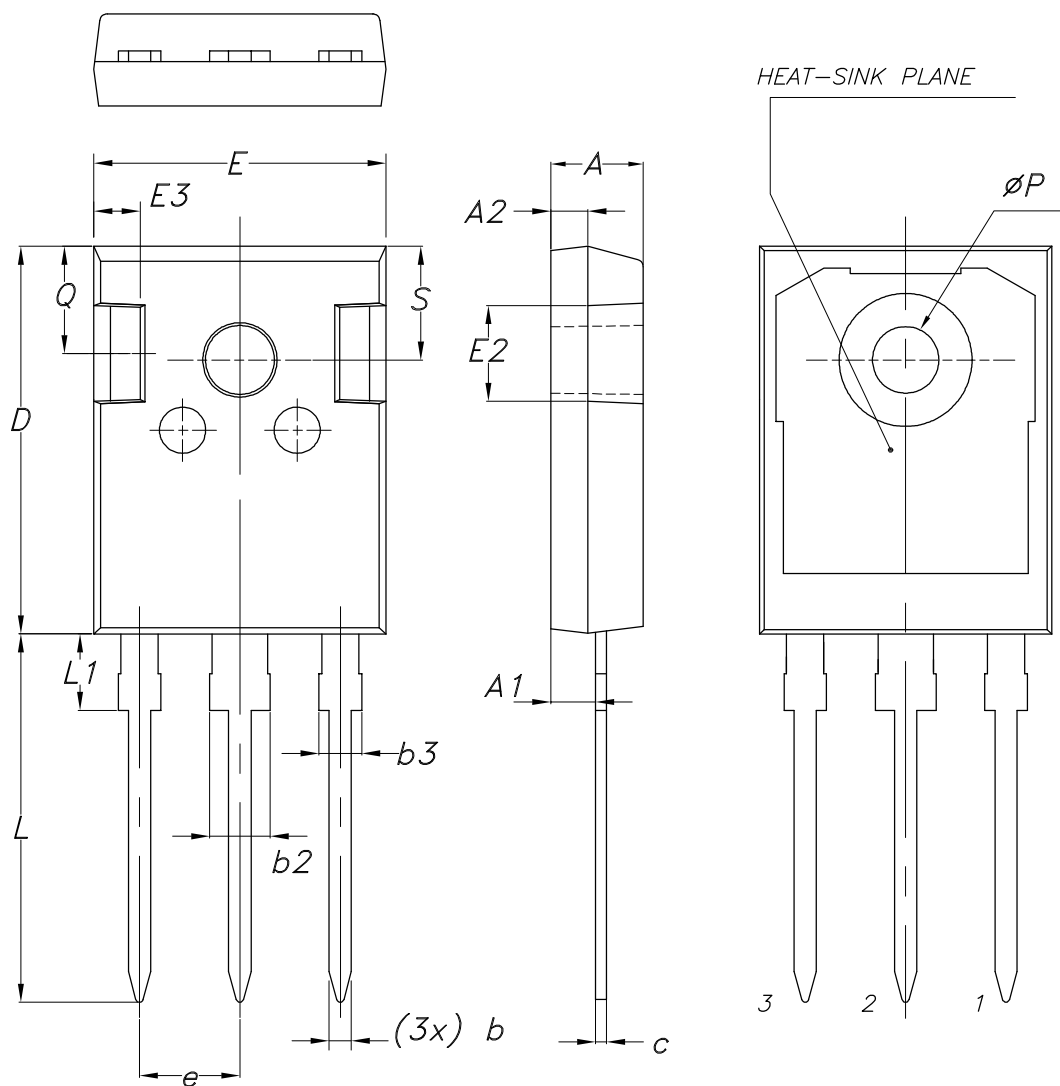
GADG180720171418SA

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 TO-247 long leads package information

Figure 32. TO-247 long leads package outline



8463846_2_F

Table 7. TO-247 long leads package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
c	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
P	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25

Revision history

Table 8. Document revision history

Date	Version	Changes
20-Jun-2018	1	Initial release. This part number was previously included in datasheet DS10300.

Contents

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